

BAR42 BAR43

Small signal Schottky diode

Datasheet - production data



General purpose metal to silicon diodes featuring very low turn-on voltage and fast switching.

K NC	• А • к	A K1 K2	• K1 • A • K2
BAR42FIL	м	BAR43AFI	LM
BAR43FILI			
A1	• A1 • K • A2	A1 K2 K1	• A2 • A1 • K1 • K1
BAR43CFI	LM	BAR43ASF	ILM
	SOT	Г23-3L	

Table 1. Device summary

Symbol	Value
I _{F(AV)}	0.1 A
V _{RRM}	30 V
Тj	150 °C
V _F (max)	0.33 and 0.40 V

Features

- Very small conduction losses
- Negligible switching losses
- Low forward voltage drop
- Surface mount device

This is information on a product in full production.

Characteristics 1

Symbol	Parameter	Value	Unit				
V _{DRM}	Repetitive peak off-state voltage	30	V				
I _{F(AV)}	Continuous forward current	0.1	А				
I _{FSM}	Surge non repetitive forward current $t_p = 10 \text{ ms sinusoidal}$		0.75	А			
P _{tot}	Power dissipation ⁽¹⁾ $T_{amb} = 25 \text{ °C}$		250	mW			
T _{stg}	Maximum Storage temperature range	- 65 to + 150	°C				
Тj	Maximum operating junction temperatur	150	°C				
Τ _L	Maximum temperature for soldering during 10 s		260	°C			

Table 2. Absolute ratings (limiting values)

1. For double diodes, P_{tot} is the total dissipation of both diodes

 $\frac{dPtot}{dTj} < \frac{1}{Rth(j-a)}$ condition to avoid thermal runaway for a diode on its own heatsink. 2.

Table 3. Thermal parameter

Symbol	Parameter	Value	Unit
R _{th(j-a)}	Junction to ambient ⁽¹⁾	500	°C/W

1. Mounted on epoxy board with recommended pad layout.

Symbol	Parameter	Test conditions		Min.	Тур.	Max.	Unit	
V_{BR}	Breakdown voltage	T _j = 25 °C		I _R = 100 μA	30			V
I _R ⁽¹⁾	Reverse leakage	T _j = 25 °C	T _j = 25 °C				500	nA
'R `´	current	T _j = 100 °C		$V_R = V_{RRM}$			100	μΑ
			BAR42	I _F = 10 mA		0.35	0.40	
			BAR42	I _F = 50 mA		0.50	0.65	
V _F ⁽²⁾	Forward voltage	$I_i = 25^{-1}$	BAR43	I _F = 2 mA	0.26		0.33	V
		DAR43	I _F = 15 mA			0.45		
		ALL		I _F =100 mA			1	

Table 4. Static electrical characteristics

1. Pulse test: t_p = 5 ms, δ < 2 %

2. Pulse test: t_p = 380 µs, δ < 2 %



I_{FM}(A)

2.00E-2

1.80E-2 1.60E-2

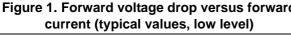
1.40E-2 1.20E-2 1.00E-2 8.00E-3

6.00E-3 4.00E-3 2.00E-3

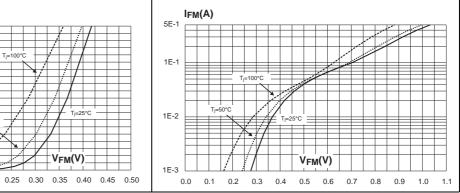
0.00E+0

Table 5. Dynamic characteristics (1) = 25 °C/						
Symbol	Test conditions		Min.	Тур.	Max.	Unit
С	Junction capacitance	$T_j = 25 \text{ °C}$ $V_R = 1 \text{ V}$ $F = 1 \text{ MHz}$		7		pF
С	Reverse recovery time	$ I_F = 10 \text{ mA} I_R = 10 \text{ mA} \\ T_j = 25 \text{ °C} I_{rr} = 1 \text{ mA} R_L = 100 \Omega $			5	pF
η	Detection efficiency	$\begin{array}{l} C_{L} = 300 \; pF F = 45 \; MHz \\ T_{j} = 25 \; ^{\circ} C V_{i} = 2 \; V R_{L} = 50 \; \Omega \end{array}$	80			ps

Table 5 Dynamic characteristics (Ti = $25 \,^{\circ}$ C)





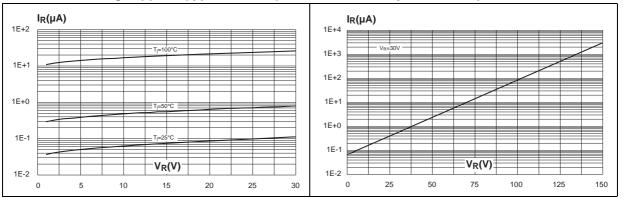




VFM(V)

reverse voltage applied (typical values)

Figure 4. Reverse leakage current versus junction temperature





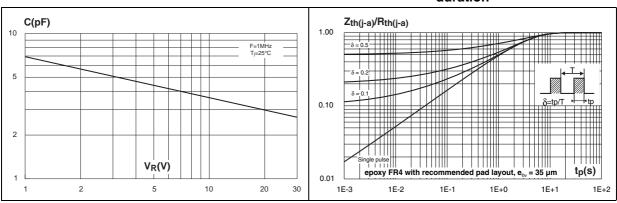


Figure 5. Junction capacitance versus reverse voltage applied (typical values)

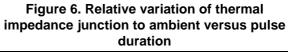
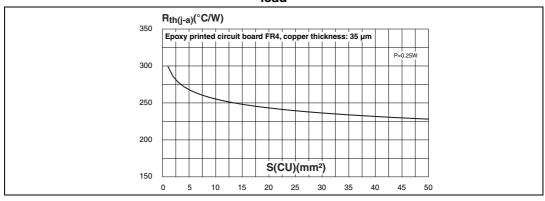


Figure 7. Thermal resistance junction to ambient versus copper surface under each lead





2 Package information

- Epoxy meets UL94, V0
- Lead-free packages

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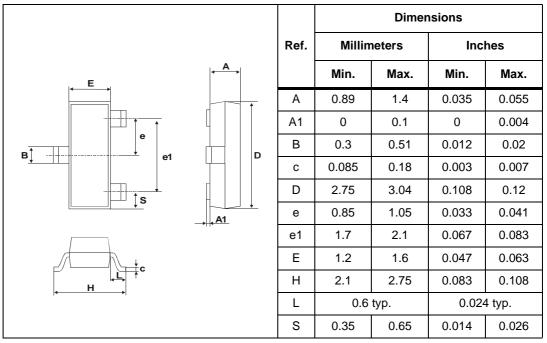
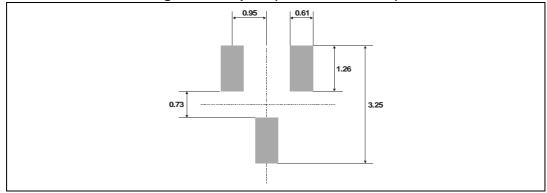


Table 6. SOT23-3L dimensions

Figure 8. Footprint (dimensions in mm)





3 Ordering information

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Order code	Marking	Package	Weight	Base Qty	Delivery mode	
BAR42FILM	D94					
BAR43FILM	D95					
BAR43AFILM	DB1	SOT23-3L	0.01 g	3000	Tape and reel	
BAR43CFILM	DB2					
BAR43SFILM	DA5					

Table 7. Ordering information

4 Revision history

Date	Revision	Changes	
Aug-2001	2B	Last release.	
16-Apr-2005	3	Layout update. No content change.	
23-Apr-2014	4	Updated ECOPACK statement.	

Table 8.	Document	revision	history
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